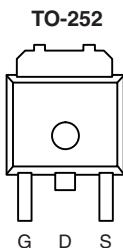


<b>PRODUCT SUMMARY</b>			
<b>V<sub>DS</sub> (V)</b>	<b>R<sub>DS(on)</sub> (Ω)</b>	<b>I<sub>D</sub> (A)</b>	<b>Q<sub>g</sub> (Typ.)</b>
<b>- 40</b>	0.0081 at V <sub>GS</sub> = - 10 V	- 50 <sup>d</sup>	60
	0.0117 at V <sub>GS</sub> = - 4.5 V	- 48 <sup>d</sup>	

**FEATURES**

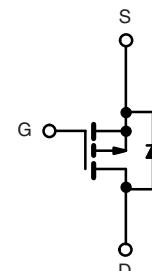
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



Drain Connected to Tab

Top View

Ordering Information: SUD50P04-08-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

**ABSOLUTE MAXIMUM RATINGS** T<sub>C</sub> = 25 °C, unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	- 40	V
Gate-Source Voltage	V <sub>GS</sub>	± 20	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C	- 50 <sup>d</sup>	A
	T <sub>C</sub> = 70 °C	- 50 <sup>d</sup>	
Pulsed Drain Current	I <sub>DM</sub>	- 100	
Avalanche Current	I <sub>AS</sub>	- 46	
Single Avalanche Energy <sup>a</sup>	E <sub>AS</sub>	106	mJ
Maximum Power Dissipation <sup>a</sup>	T <sub>C</sub> = 25 °C	73.5 <sup>b</sup>	W
	T <sub>A</sub> = 25 °C <sup>c</sup>	2.5	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C

**THERMAL RESISTANCE RATINGS**

Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) <sup>c</sup>	R <sub>thJA</sub>	50	°C/W
Junction-to-Case (Drain)	R <sub>thJC</sub>	1.7	

Notes:

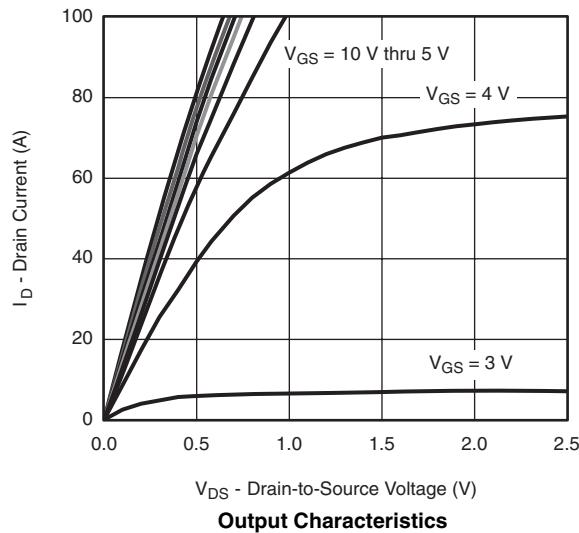
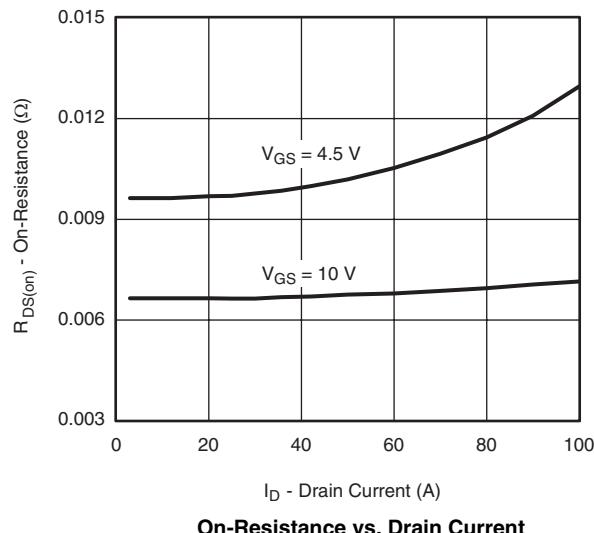
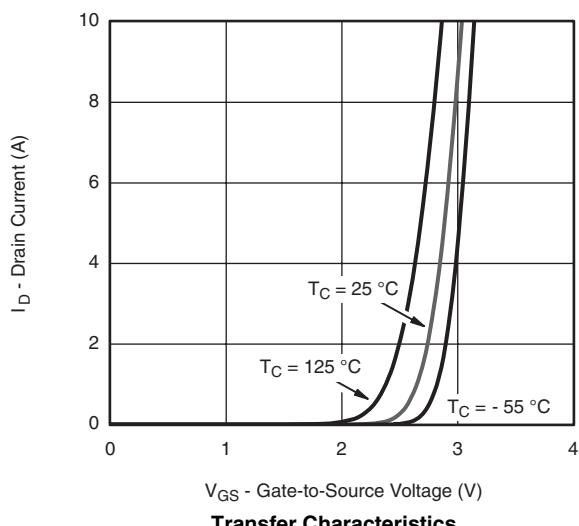
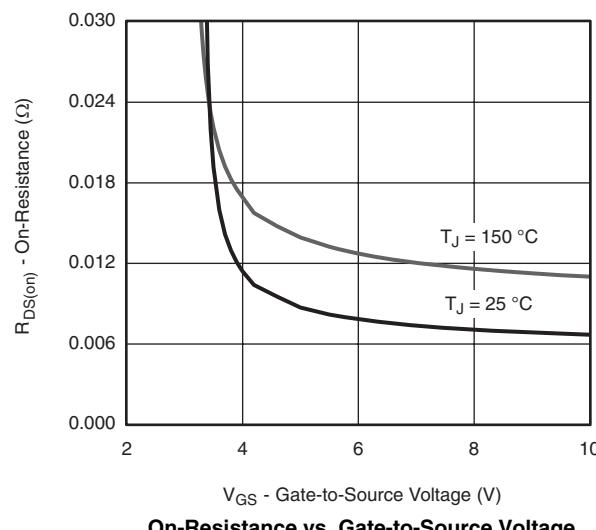
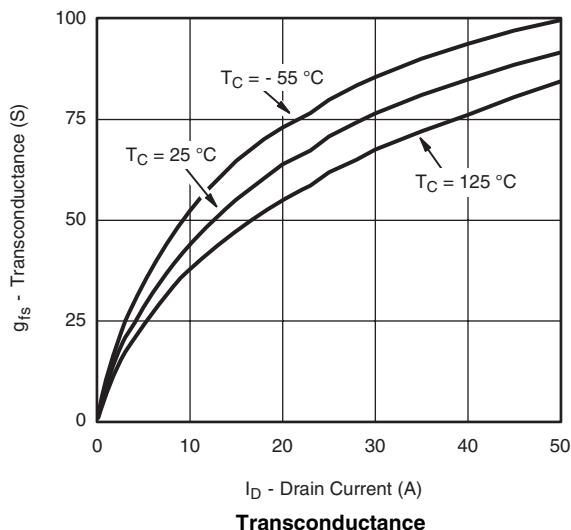
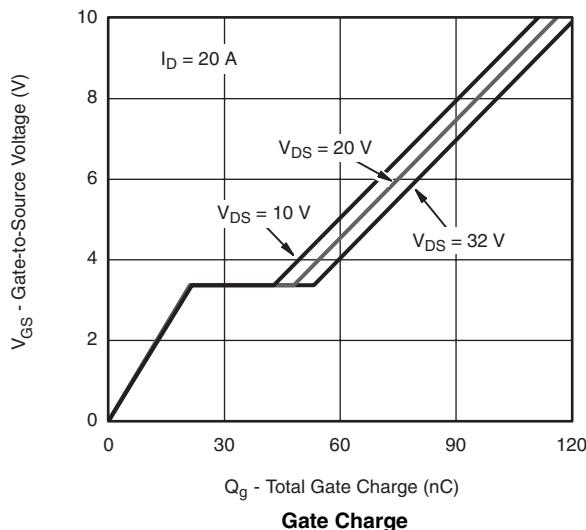
- a. Duty cycle ≤ 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).
- d. Package limited.

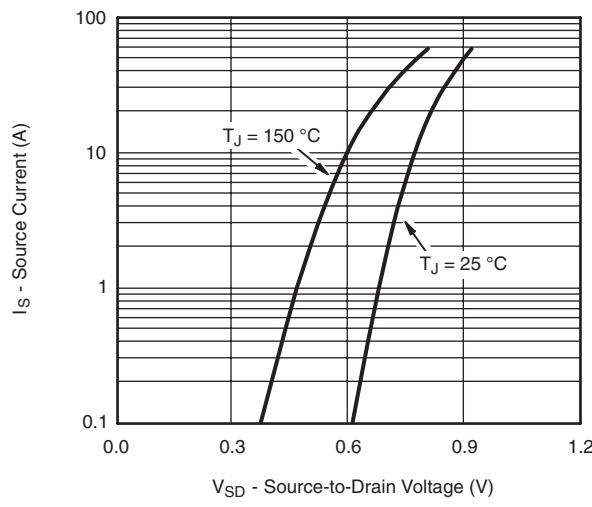
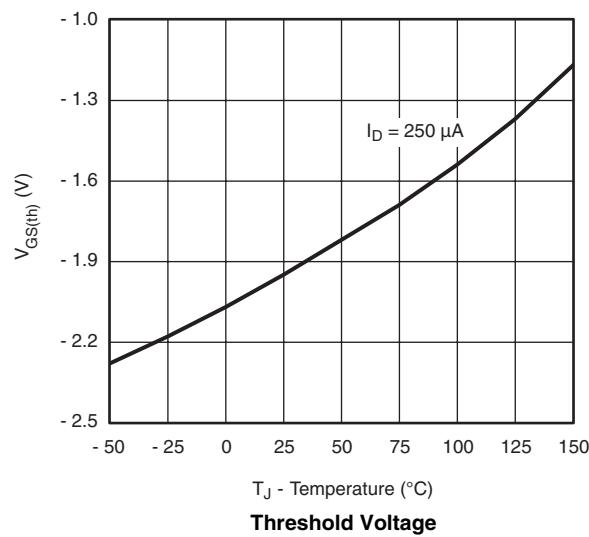
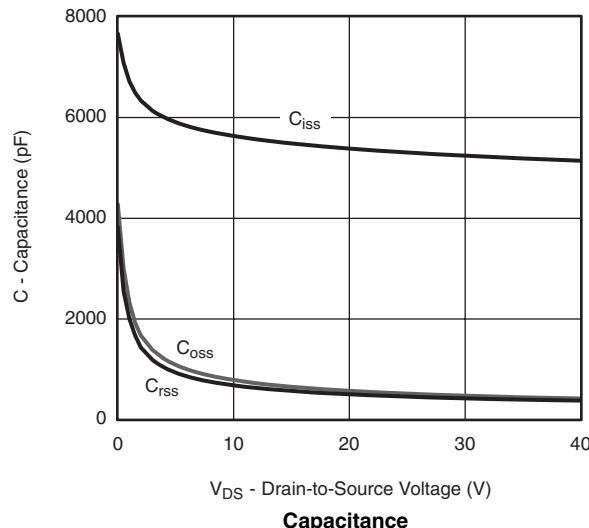
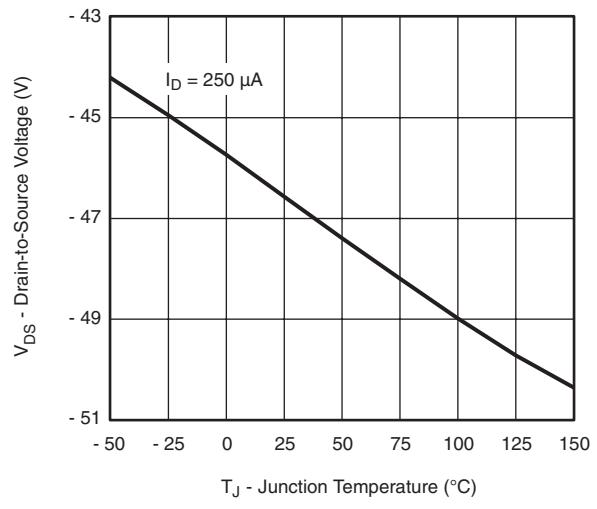
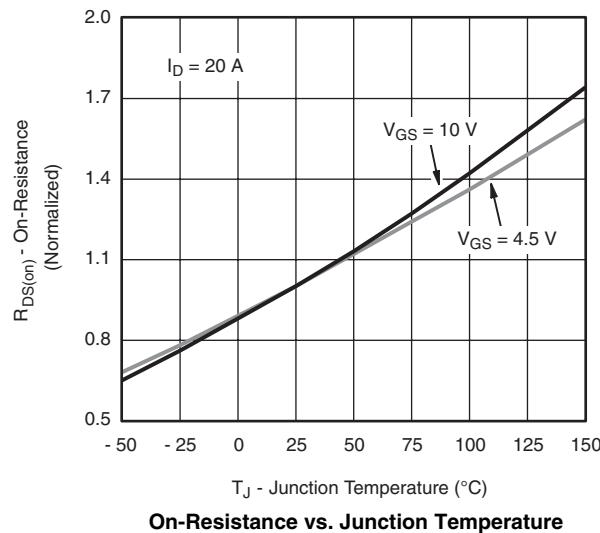
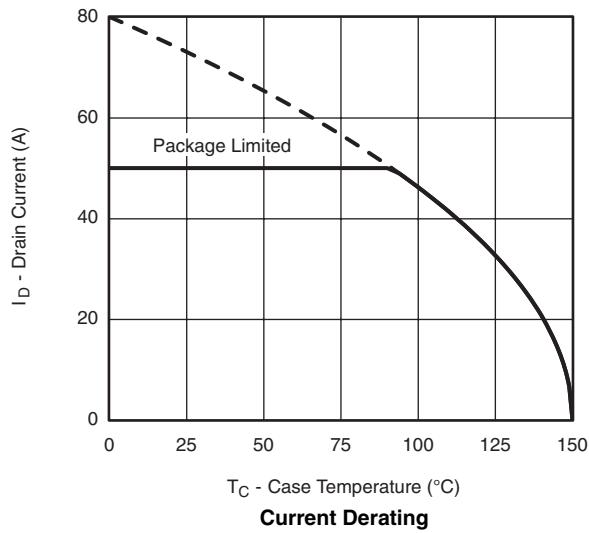
<b>SPECIFICATIONS</b> $T_J = 25^\circ\text{C}$ , unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{DS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 40			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	- 1		- 2.5	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			$\pm 250$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	$\mu\text{A}$
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125^\circ\text{C}$			- 50	
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 150^\circ\text{C}$			- 250	
On-State Drain Current <sup>a</sup>	$I_{D(\text{on})}$	$V_{DS} \leq -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 50			A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(\text{on})}$	$V_{GS} = -10 \text{ V}, I_D = -22 \text{ A}$		0.0067	0.0081	$\Omega$
		$V_{GS} = -4.5 \text{ V}, I_D = -19 \text{ A}$		0.0097	0.0117	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = -15 \text{ V}, I_D = -22 \text{ A}$		45		S
<b>Dynamic<sup>b</sup></b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V}, V_{DS} = -20 \text{ V}, f = 1 \text{ MHz}$		5380		pF
Output Capacitance	$C_{oss}$			570		
Reverse Transfer Capacitance	$C_{rss}$			500		
Total Gate Charge <sup>c</sup>	$Q_g$	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -20 \text{ A}$		106	159	nC
Gate-Source Charge <sup>c</sup>	$Q_{gs}$			60	90	
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			22		
Gate Resistance	$R_g$		$f = 1 \text{ MHz}$	0.4	1.8	3.6
Turn-On Delay Time <sup>c</sup>	$t_{d(\text{on})}$	$V_{DD} = -20 \text{ V}, R_L = 2 \Omega$ $I_D \approx -10 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		15	23	ns
Rise Time <sup>c</sup>	$t_r$			12	18	
Turn-Off Delay Time <sup>c</sup>	$t_{d(\text{off})}$			70	105	
Fall Time <sup>c</sup>	$t_f$			18	27	
<b>Drain-Source Body Diode Ratings and Characteristics</b> $T_C = 25^\circ\text{C}^b$						
Continuous Current	$I_S$	$I_F = -10 \text{ A}, V_{GS} = 0 \text{ V}$			- 50	A
Pulsed Current	$I_{SM}$				- 100	
Forward Voltage <sup>a</sup>	$V_{SD}$			- 0.8	- 1.5	V
Reverse Recovery Time	$t_{rr}$			35	53	ns
Peak Reverse Recovery Current	$I_{RM(\text{REC})}$			- 2	- 3	A
Reverse Recovery Charge	$Q_{rr}$			33	50	nC

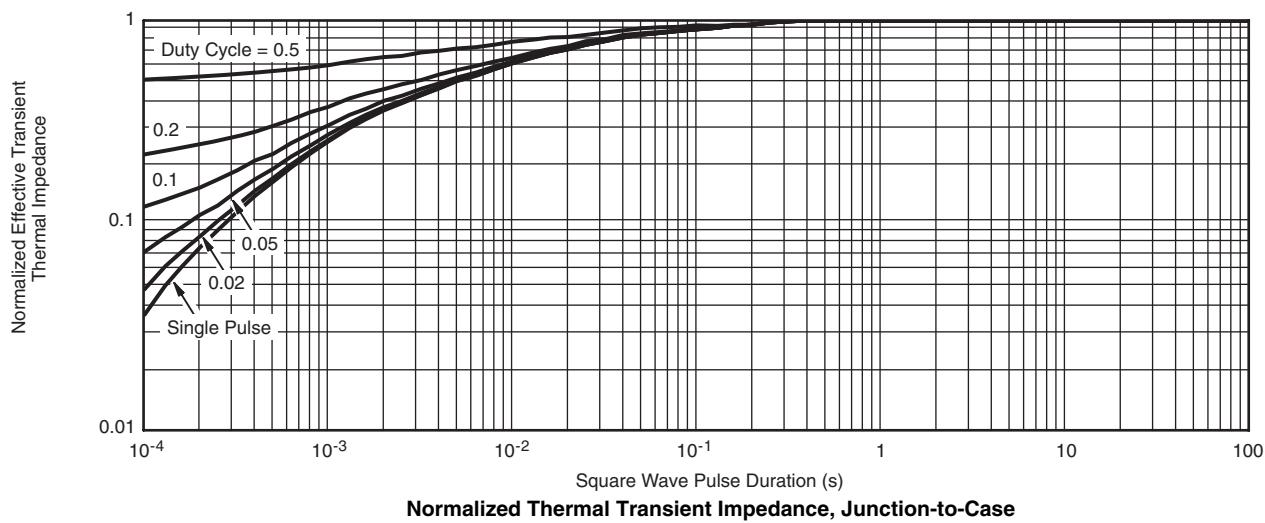
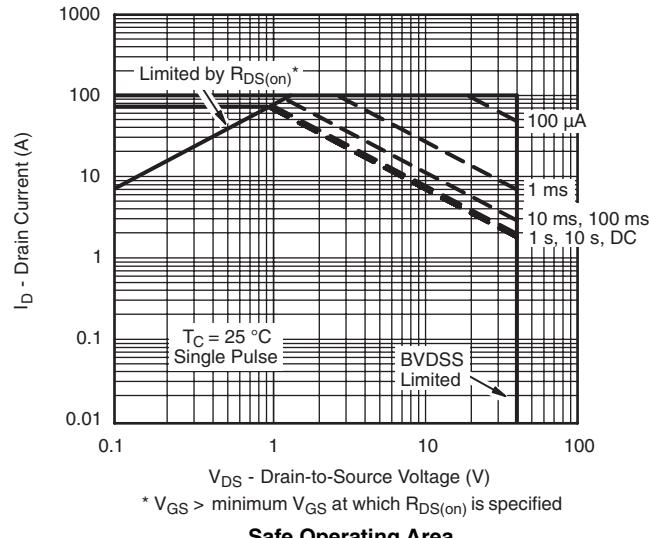
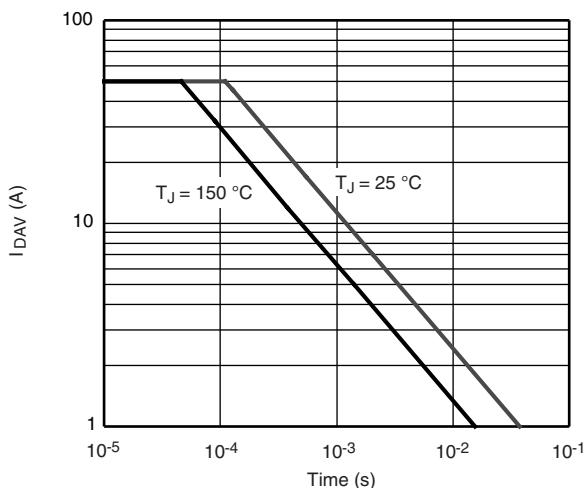
Notes:

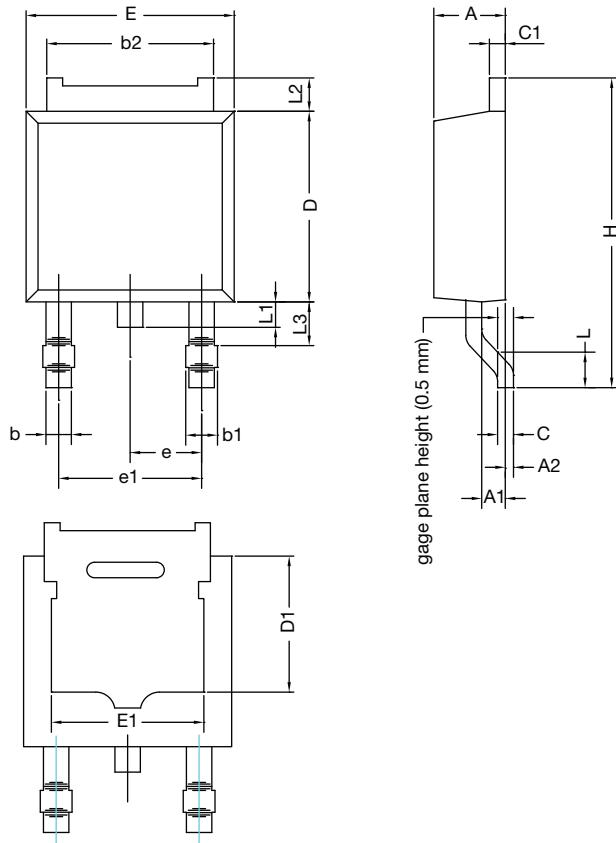
- a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

**Output Characteristics**

**On-Resistance vs. Drain Current**

**Transfer Characteristics**

**On-Resistance vs. Gate-to-Source Voltage**

**Transconductance**

**Gate Charge**

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

**Source-Drain Diode Forward Voltage**

**Threshold Voltage**

**Capacitance**

**Drain Source Breakdown vs. Junction Temperature**

**On-Resistance vs. Junction Temperature**

**Current Derating**

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


**TO-252AA CASE OUTLINE**


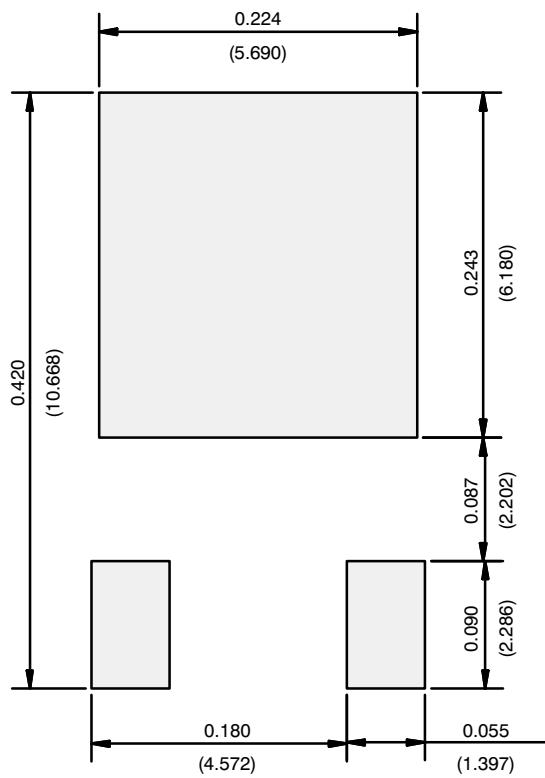
DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.21	2.38	0.087	0.094
A1	0.89	1.14	0.035	0.045
A2	0.030	0.127	0.001	0.005
b	0.71	0.88	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.44	0.206	0.214
C	0.46	0.58	0.018	0.023
C1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
D1	4.10	4.45	0.161	0.175
E	6.48	6.73	0.255	0.265
E1	4.49	5.50	0.177	0.217
e	2.28 BSC		0.090 BSC	
e1	4.57 BSC		0.180 BSC	
H	9.65	10.41	0.380	0.410
L	1.40	1.78	0.055	0.070
L1	0.64	1.02	0.025	0.040
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.040	0.060

ECN: T11-0110-Rev. L, 18-Apr-11  
DWG: 5347

**Note**

- Dimension L3 is for reference only.

**RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads  
Dimensions in Inches/(mm)

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